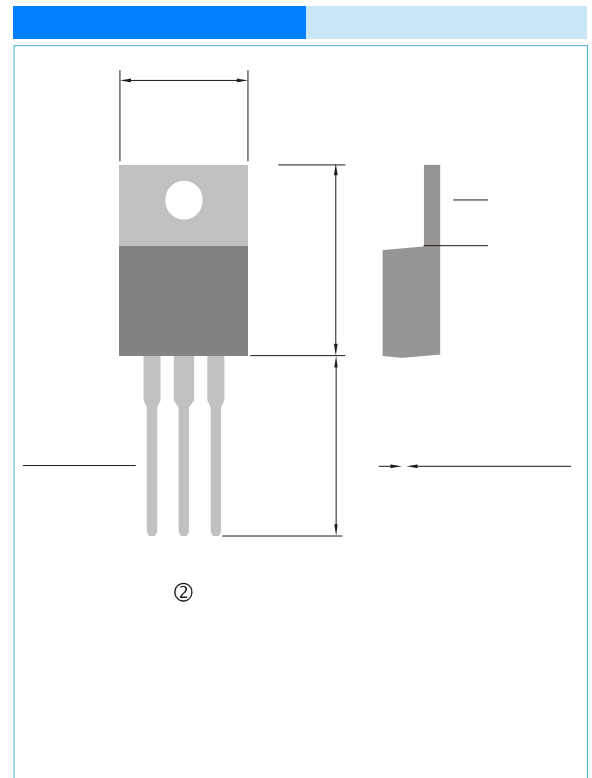


FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-O. Flame Retardant Epoxy Molding Compound.
- Low power loss, high efficiency.
- Low forward voltage, high current capability
- High surge capacity.
- Super fast recovery times, high voltage.
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. . (Halogen Free)

MECHANICAL DATA

- Case: TO-220AB Molded plastic
- Terminals: Lead solderable per MIL-STD-750, Method 2026
- Polarity: As marked.
- Standard packaging: Any
- Weight: 0.067 ounces, 1.89 grams.



MAXIMUM RATING AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%

PARAMETER	SYMBOL	MUR 1020CT	MUR 1040CT	MUR 1060CT	MUR 1080CT	MUR 10100CT	
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	200	400	600	800	1000	V
Maximum Average Forward Current at $T_C = 100^\circ\text{C}$	$I_{F(AV)}$	10					A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	150					A
Maximum Forward Voltage at 5A, per element	V_F	0.95	1.3	1.5	1.7	1.9	V
Maximum DC Reverse Current at Rated DC Blocking Voltage $T_J = 25^\circ\text{C}$ $T_J = 100^\circ\text{C}$	I_R	10 500					μA
Maximum Reverse Recovery Time (Note 2)	t_{rr}						
Typical Junction Capacitance (Note 1)	C_J	62					pF
Typical Thermal Resistance	$R_{\theta JC}$	3					$^\circ\text{C} / \text{W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150					$^\circ\text{C}$

NOTES :

1. Measured at 1 MHz and applied reverse voltage of 4 VDC.
2. Reverse Recovery Test Conditions: $I_F = 0.5\text{A}$, $I_R = 1\text{A}$, $I_{rr} = 0.25\text{A}$.
3. Both Bonding and Chip structure are available.

RATING AND CHARACTERISTIC CURVES

